

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT						
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT						
<b>CONVEYING PARTY DATA</b>							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Takayuki Nishiura</td> <td>05/29/2006</td> </tr> <tr> <td>Tamaki Uemura</td> <td>05/24/2006</td> </tr> </tbody> </table>		Name	Execution Date	Takayuki Nishiura	05/29/2006	Tamaki Uemura	05/24/2006
Name	Execution Date						
Takayuki Nishiura	05/29/2006						
Tamaki Uemura	05/24/2006						
<b>RECEIVING PARTY DATA</b>							
<b>Name:</b>	Sumitomo Electric Industries, Ltd.						
<b>Street Address:</b>	5-33 Kitahama 4-chome, Chuo-ku						
<b>City:</b>	Osaka-shi						
<b>State/Country:</b>	JAPAN						
<b>Postal Code:</b>	541-0041						
<b>PROPERTY NUMBERS Total: 1</b>							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11425394</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11425394		
Property Type	Number						
Application Number:	11425394						
<b>CORRESPONDENCE DATA</b>							
<b>Fax Number:</b>	(703)997-4565						
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<b>Address Line 2:</b>	Dojima Bldg., 7th Fl.						
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<b>ATTORNEY DOCKET NUMBER:</b>	39.078						
<b>NAME OF SUBMITTER:</b>	James Judge						
<b>Total Attachments: 1</b> source=SM078_assgn#page1.tif							

OP \$40.00 11425394

## ASSIGNMENT OF PATENT APPLICATION

Whereas, Takayuki NISHIURA and Tomoki UEMURA  
citizen(s) of Japan and hereinafter referred to as the applicant(s), has invented certain new and useful improvements in

METHOD OF SURFACE TREATING SUBSTRATES AND METHOD OF MANUFACTURING  
III-V COMPOUND SEMICONDUCTORS

- for which the applicant(s) executed an application for United States Patent on the latest date next to the signature(s) below, or otherwise on \_\_\_\_\_,
- for which United States Patent Application Number \_\_\_\_\_/\_\_\_\_\_ was filed on \_\_\_\_\_,

and whereas, Sumitomo Electric Industries, Ltd., a corporation organized and existing  
under the laws of Japan and

hereinafter referred to as the assignee, whose mailing address is

5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka, 541-0041 Japan

is desirous of acquiring the entire rights in the patent application named above, and insofar as the same yields any United States patent(s), the title to and interest in the same:

Now, therefore, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the applicant(s) assigns, and transfers, unto the assignee, the entire rights in the patent application, and the title to and interest in the same insofar as the same yields any United States patent(s); and the applicant(s) hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all any such patent(s) to the assignee, as that of the entire title to and interest in any such patent(s), for the sole use and behoof of the assignee and the assignee's legal representatives, as fully and entirely as any such patent(s) would have been held by the applicant(s) had the present assignment not been made.

In testimony whereof the applicant(s) has below executed this assignment.

Signature(s) and date(s):

<u>Takayuki Nishiura</u>	<u>May, 29, 2006</u>
<u>Tomoki Uemura</u>	<u>May, 24, 2006</u>